

Selection Guide

Part No.	Emitting Color (Material)	Lens Type	Iv (ucd) [1] @ 10mA		Description
			Min.	Typ.	
KCSC03-105	Hyper Red (AlGaInP)	White Diffused	14000	27000	Common Cathode, Rt. Hand Decimal.
			*3600	*6400	

Notes:

1. Luminous intensity / luminous Flux: +/-15%.

* Luminous intensity value is traceable to CIE127-2007 standards.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Emitting Color	Typ.	Max.	Units	Test Conditions
λ_{peak}	Peak Wavelength	Hyper Red	645		nm	I _F =10mA
λ_D [1]	Dominant Wavelength	Hyper Red	630		nm	I _F =10mA
$\Delta\lambda_{1/2}$	Spectral Line Half-width	Hyper Red	28		nm	I _F =10mA
C	Capacitance	Hyper Red	35		pF	V _F =0V; f=1MHz
V _F [2]	Forward Voltage	Hyper Red	1.85	2.5	V	I _F =10mA
I _R	Reverse Current	Hyper Red		10	uA	V _R =5V

Notes:

1. Wavelength: +/-1nm.

2. Forward Voltage: +/-0.1V.

3. Wavelength value is traceable to CIE127-2007 standards.

4. Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

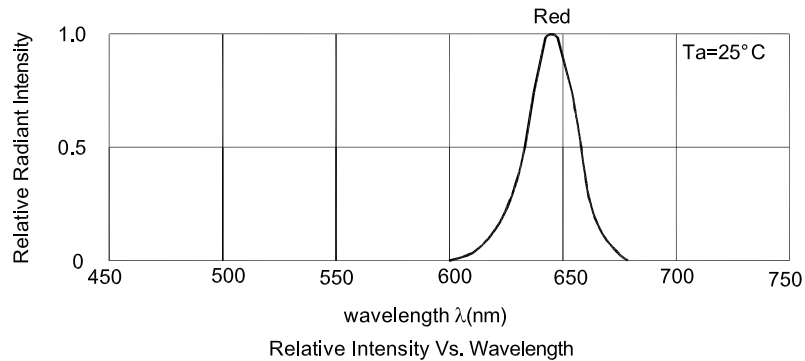
Absolute Maximum Ratings at TA=25°C

Parameter	Values	Units
Power dissipation	75	mW
DC Forward Current	30	mA
Peak Forward Current [1]	185	mA
Reverse Voltage	5	V
Operating / Storage Temperature	-40°C To +85°C	

Note:

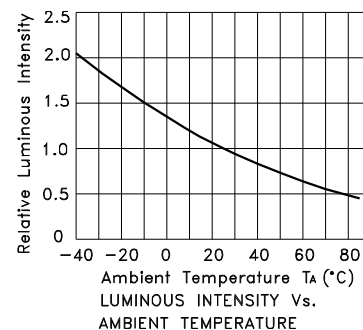
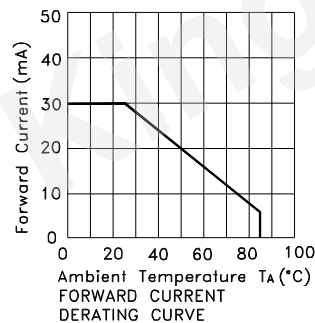
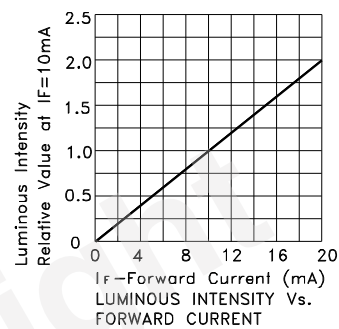
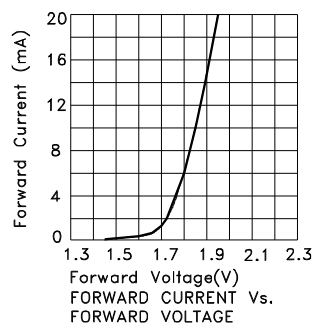
1. 1/10 Duty Cycle, 0.1ms Pulse Width.

2. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.



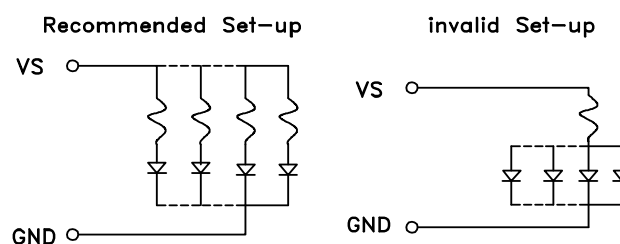
Hyper Red

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CIRCUIT DESIGN NOTES

1. Protective current-limiting resistors may be necessary to operate the Displays.
2. LEDs mounted in parallel should each be placed in series with its own current-limiting resistor.



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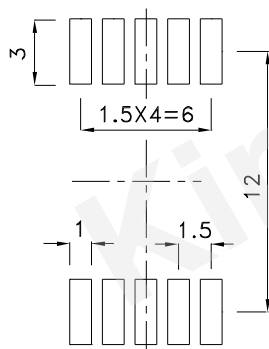
Reflow Soldering Profile For Lead-free SMT Process.



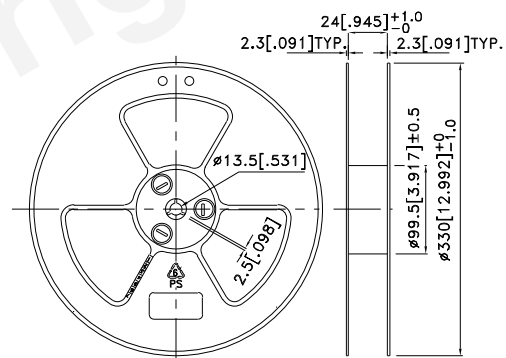
NOTES:

1. We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.
2. Don't cause stress to the epoxy resin while it is exposed to high temperature.
3. Number of reflow process shall be 2 times or less.

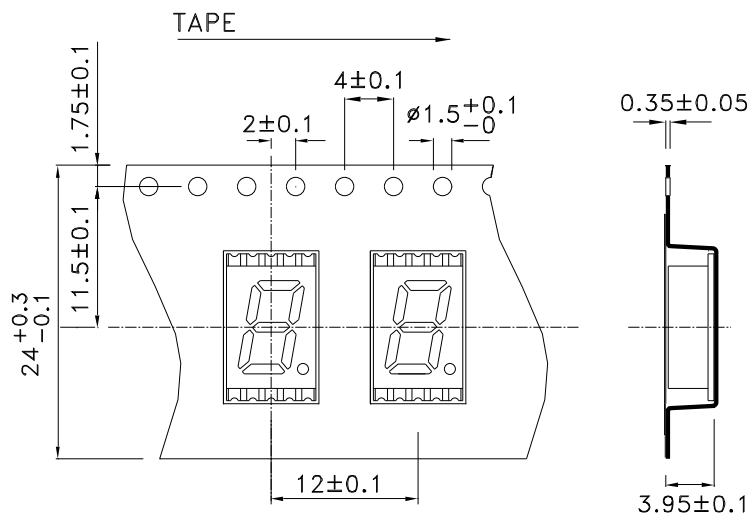
Recommended Soldering Pattern (Units : mm; Tolerance: ± 0.15)



Reel Dimension

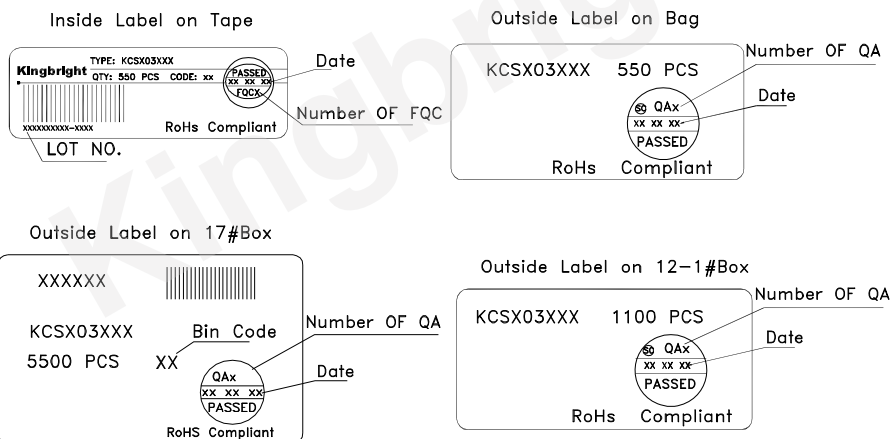
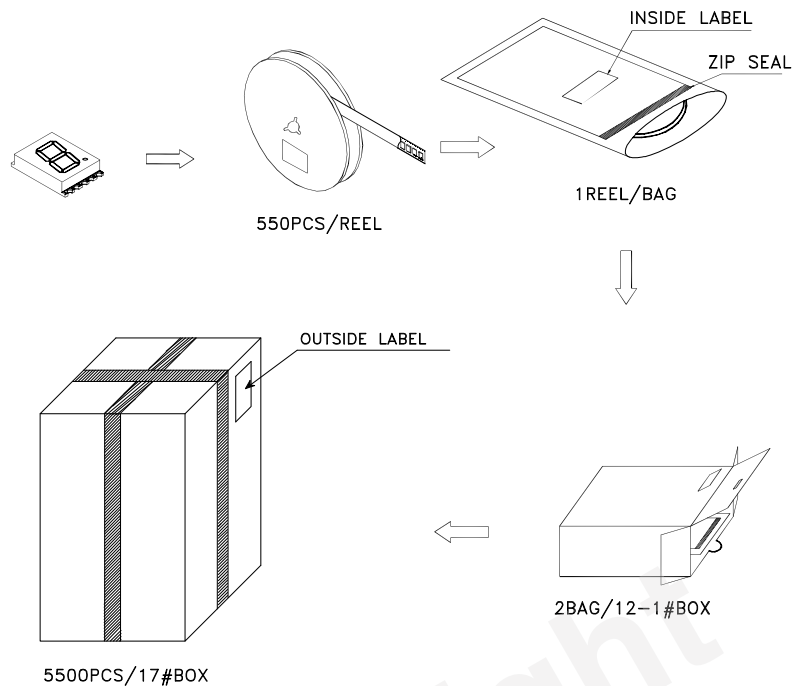


Tape Specifications (Units : mm)



PACKING & LABEL SPECIFICATIONS

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